



Improved thermal removal from Nb-Ti SC cables



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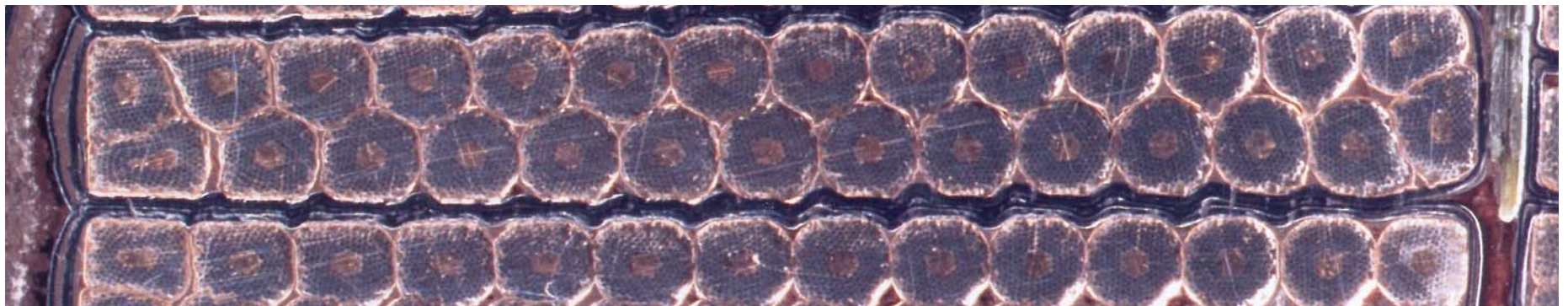
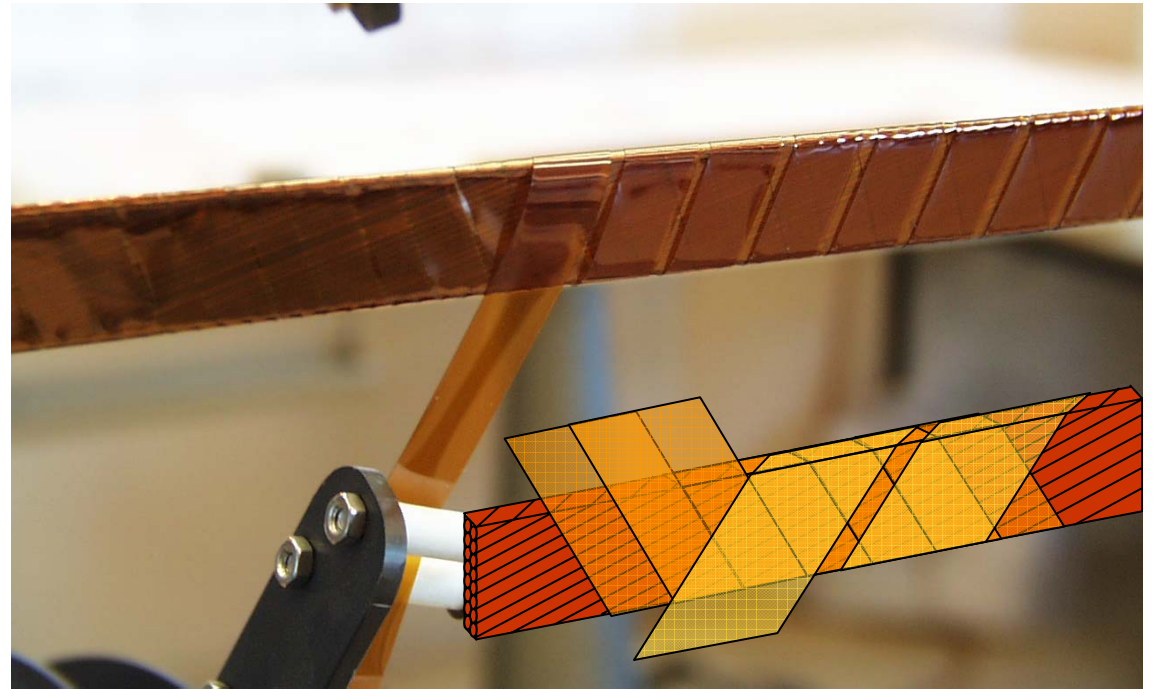
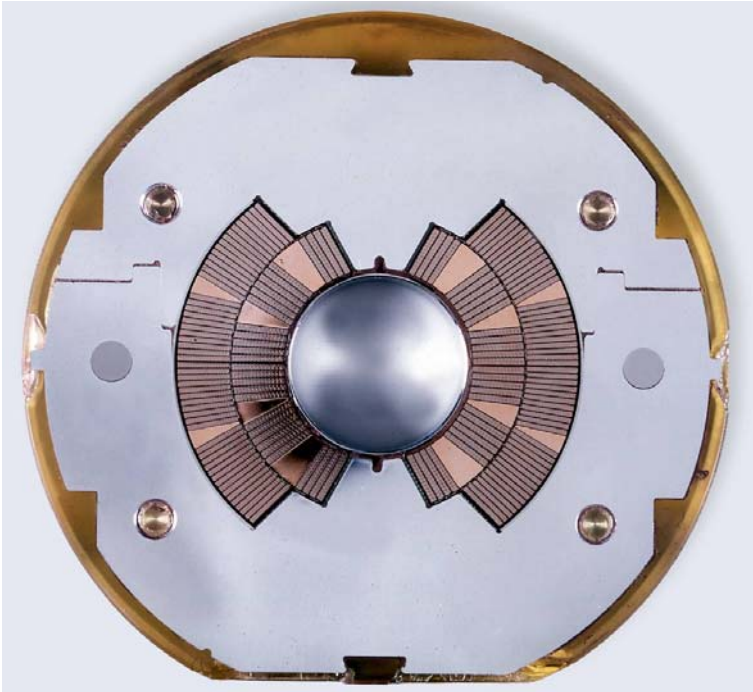
We are modeling *steady-state* heat transfer from SC Rutherford cable to an *isothermal* He II bath.

We profit of previous measurements done mostly at CEA-Saclay on different cable insulation schemes.

We show there is a potential for a large margin of improvement of heat removal with respect to present LHC schemes



Cable insulation





Heat transfer



• Nb-Ti porous insulations

• Insulations are wrapped around a steel cable mock-up, 150 mm long.

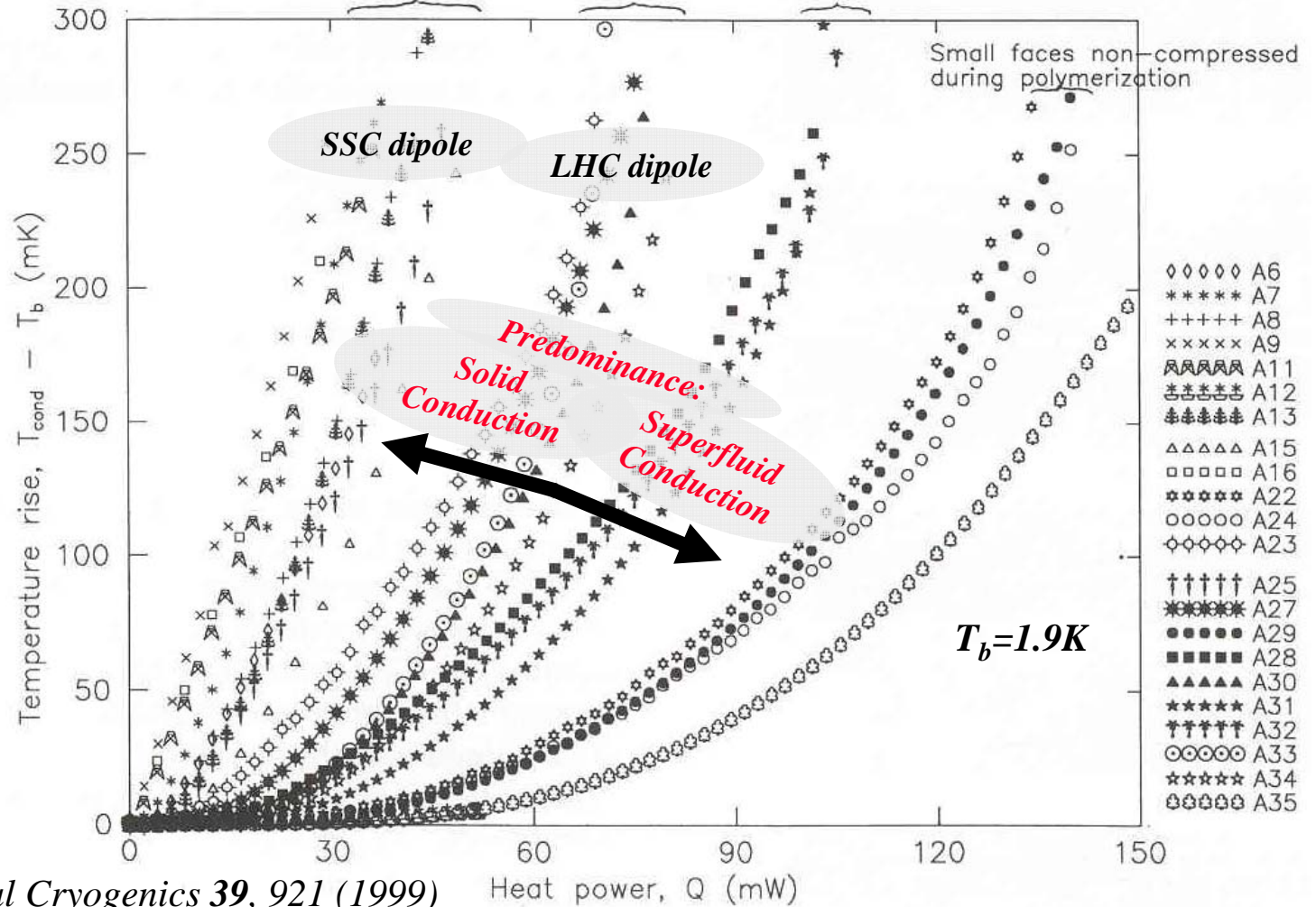
• Conductor is always wet by He II

• He II Channels saturate $T_c = T_\lambda$

Kapton 100 HN or tissue-underlaid Kapton + prepreg or Kapton adhesive on both faces

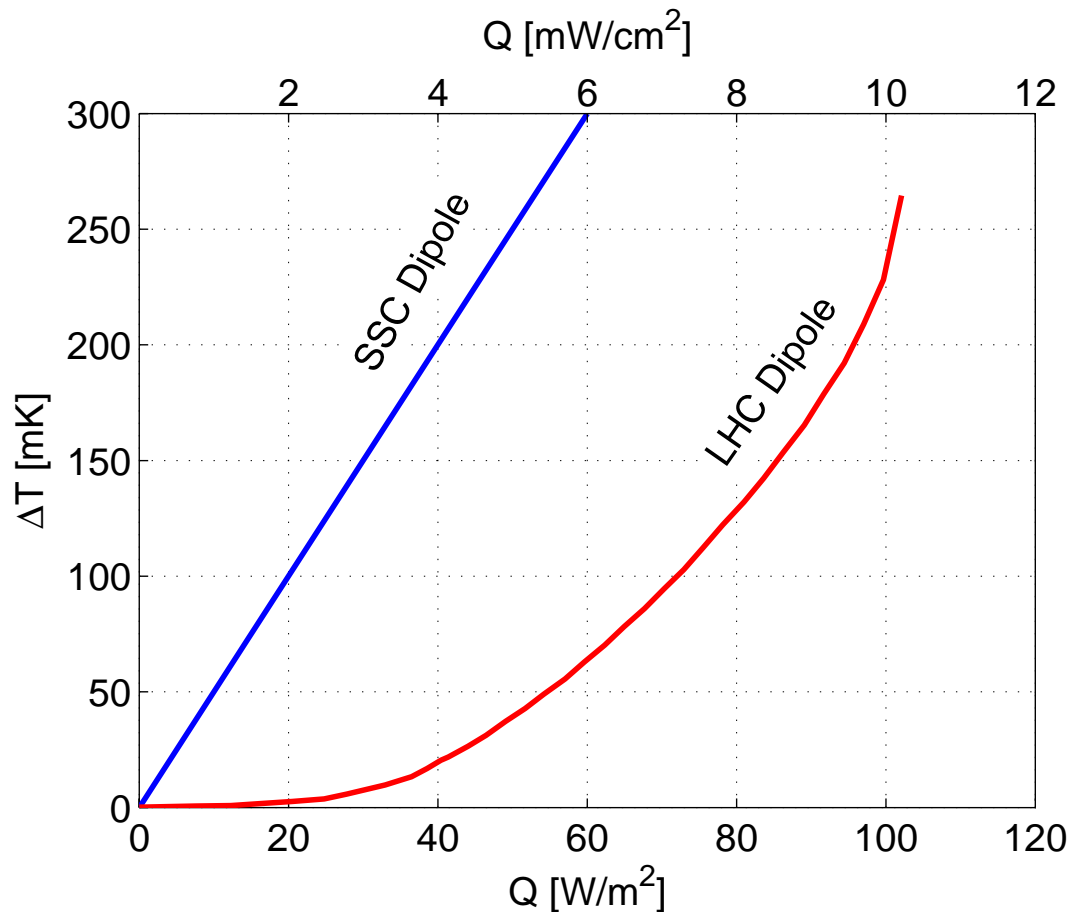
Kapton 150 HN + Kapton adhesive on outside face

Kapton 200 HN + Kapton adhesive on outside face





Heat transfer



For a LHC main dipole :

Inner cable perimeter ~ 12 cm

For $\Delta T = 150$ mK $\Rightarrow Q = 85$ W/m²

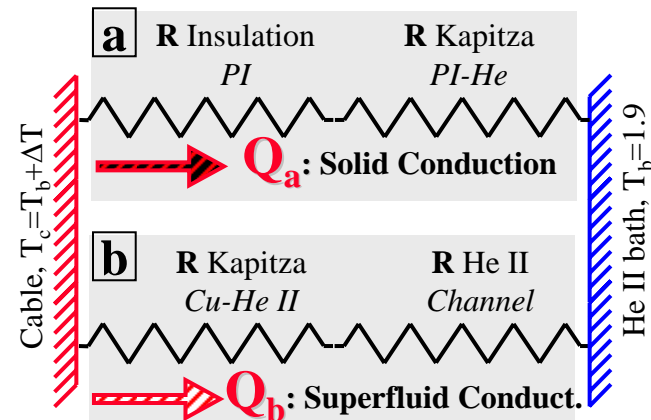
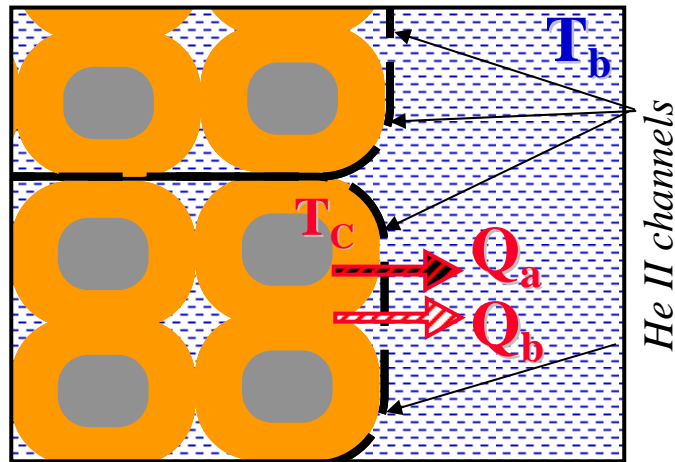


Heat transfer ~ 165 mW/m per turn

IF UNIFORMELY DISTRIBUTED

~10 W/m per aperture

Elaborated from B. Baudouy et al Cryogenics 39, 921 (1999)



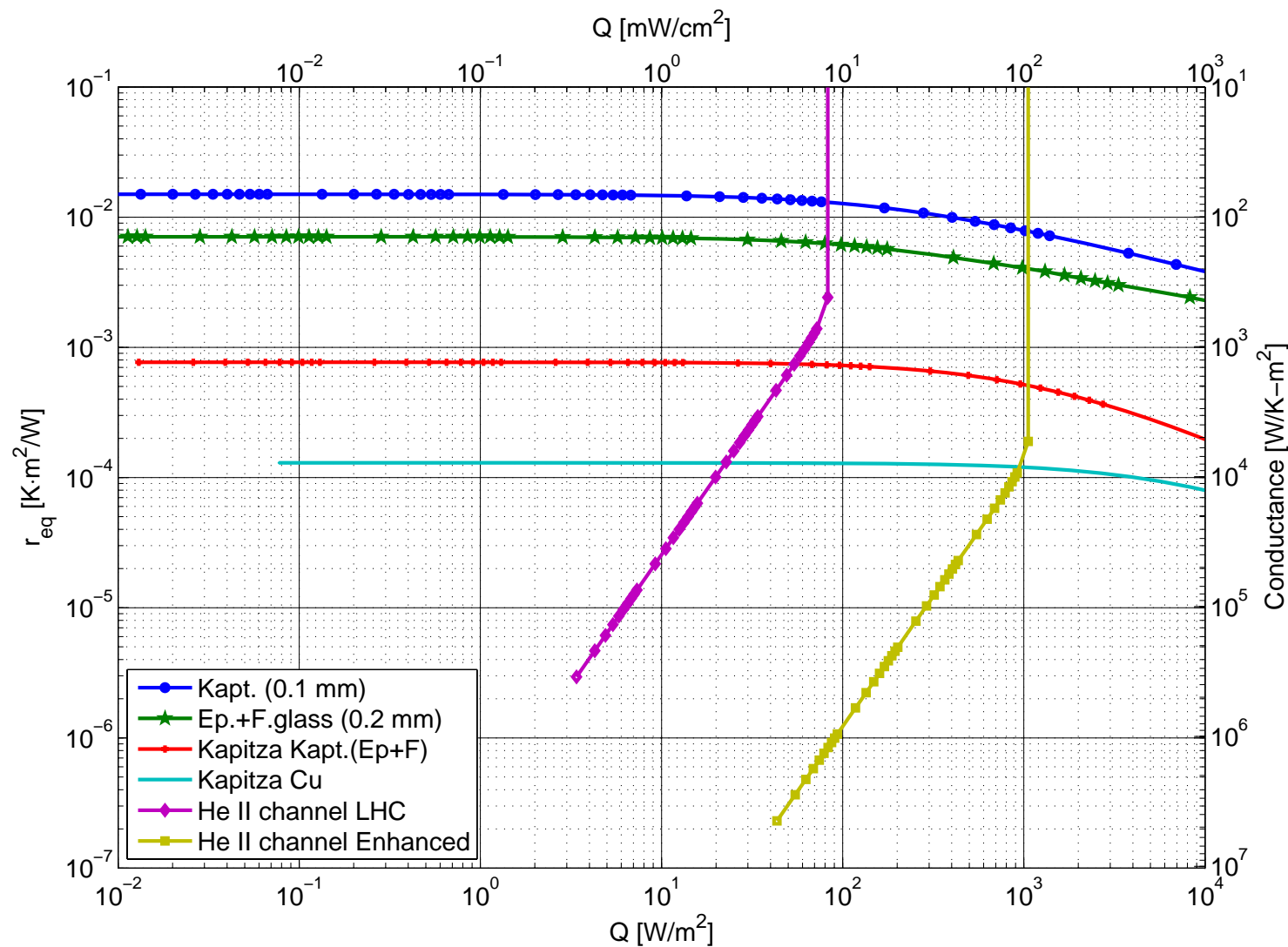
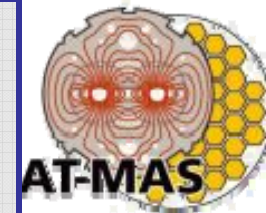
- 1) Q_a vs Q_b depends on insulation porosity
- 2) Q_a & Q_b are non linear
- 3) Q_b has saturation level

Assumptions:

- Negligible thermal boundary resistance at the strand-insulation interface [3,4]
- Parallel paths are decoupled
- Conductor and He II bath are isothermal
- He II heat transfer regime is Gorter-Mellink [5] (may lead to under-estimate [6]).

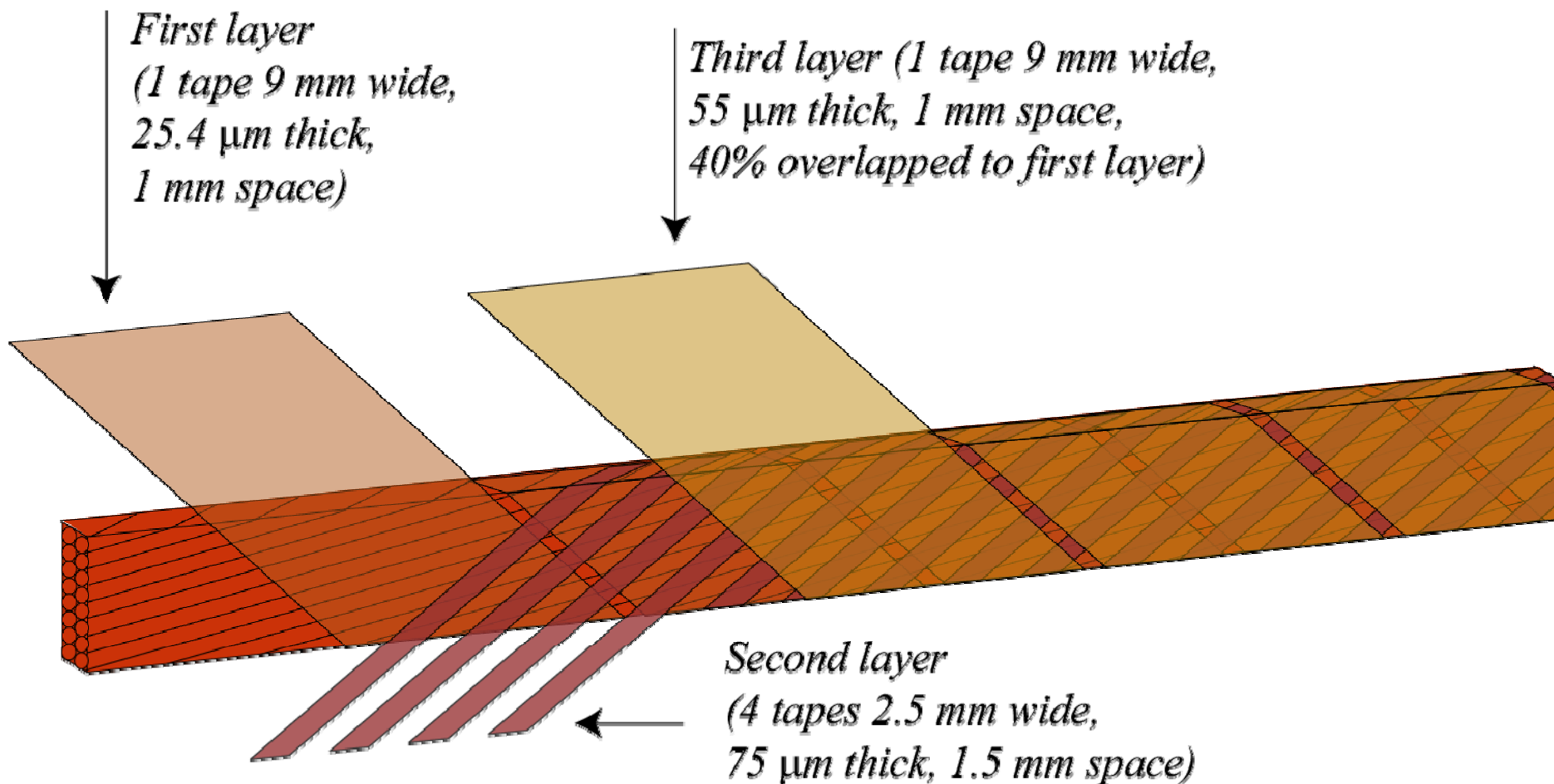


Comparison of Equivalent Thermal Resistances in an Insulated Cable



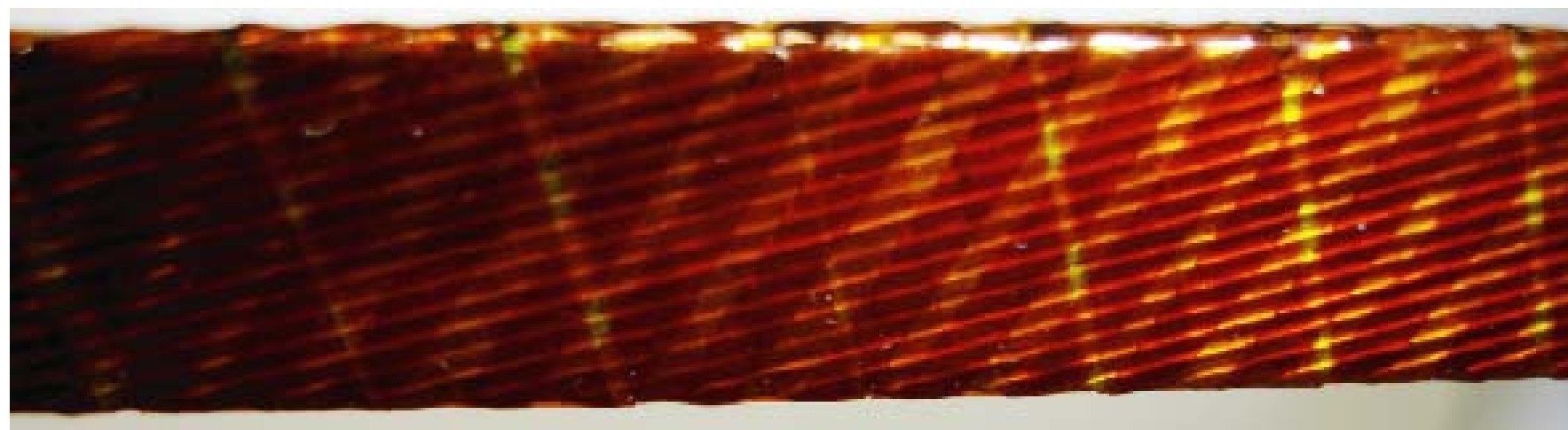


Enhanced Porosity



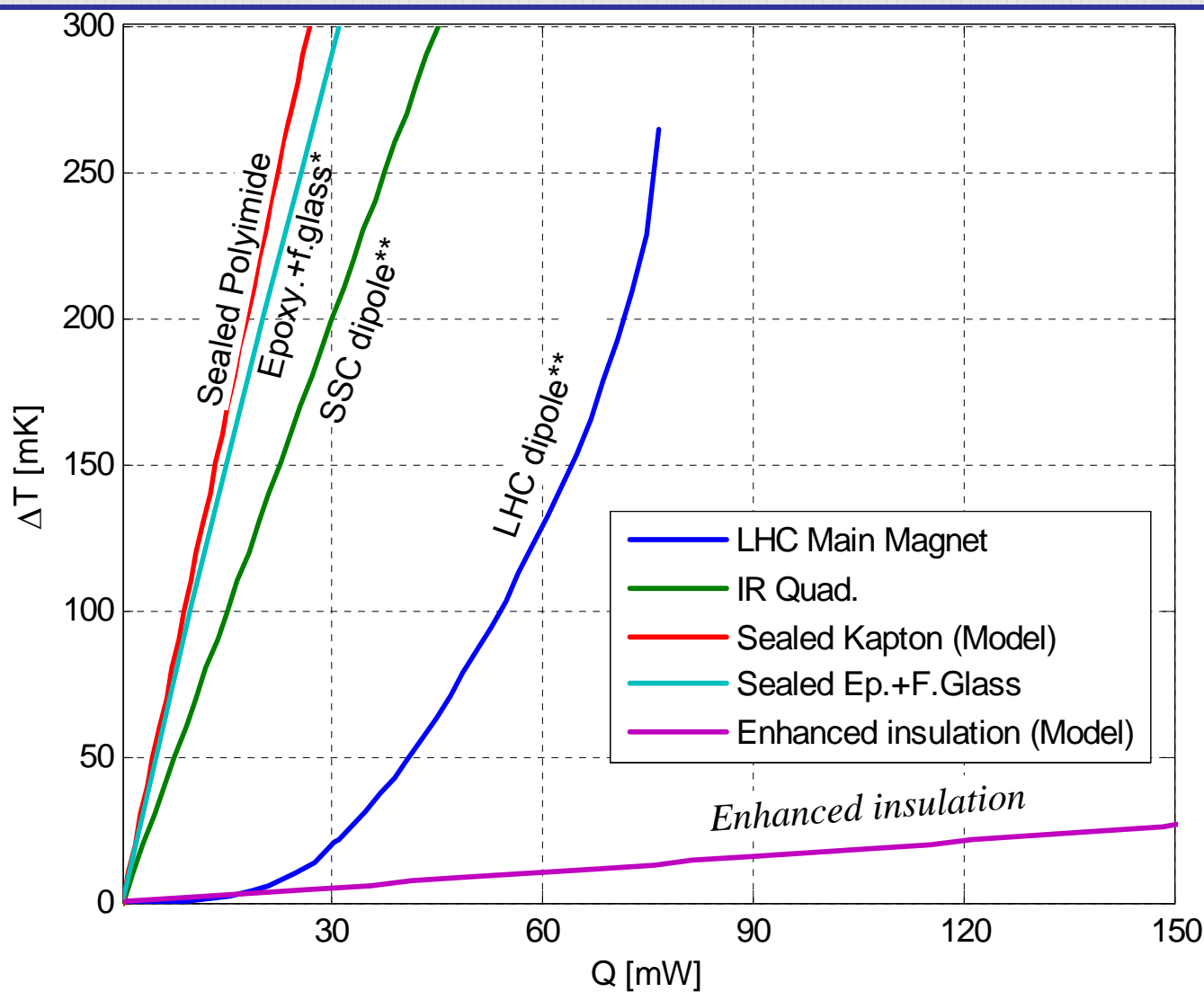


Enhanced Porosity



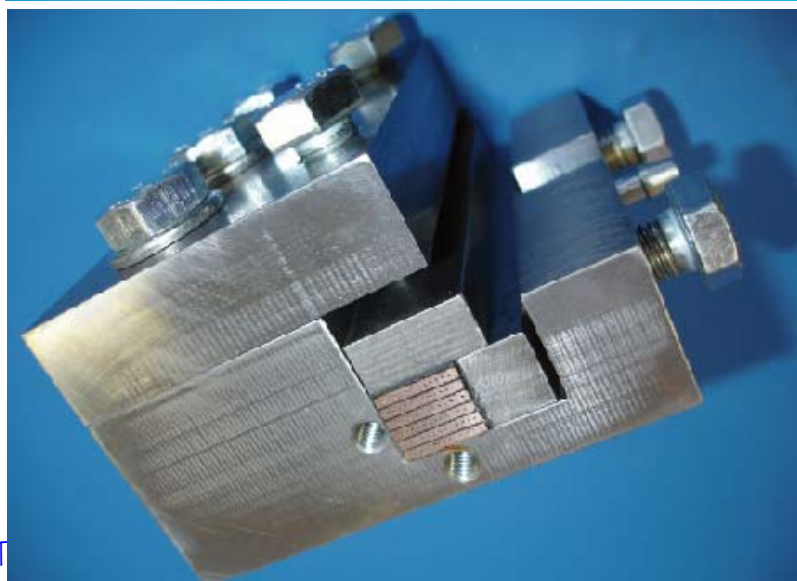
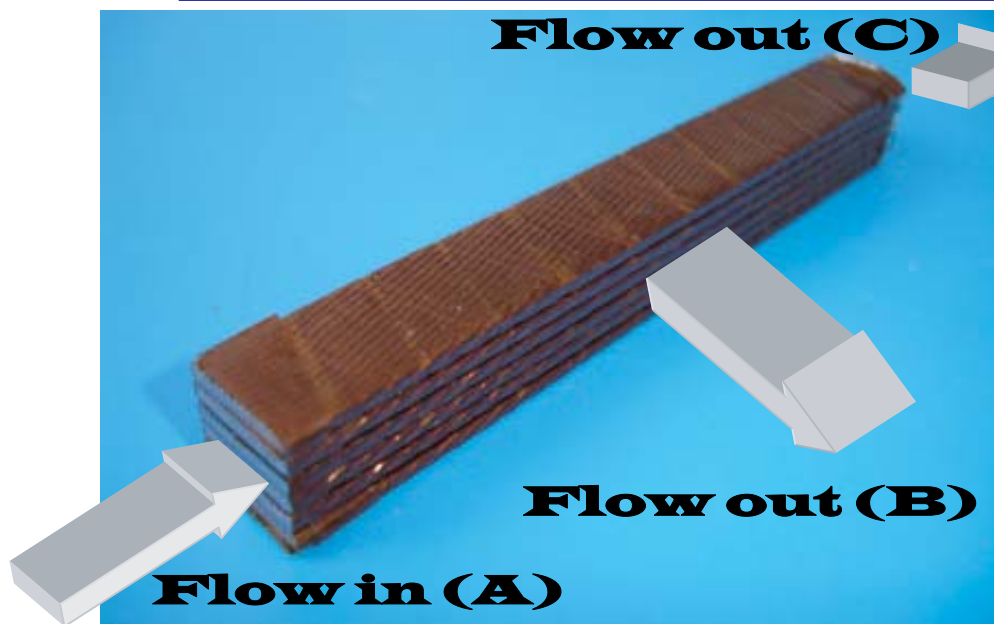


Summary of thermal transfer



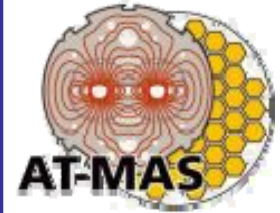


Porosity tests



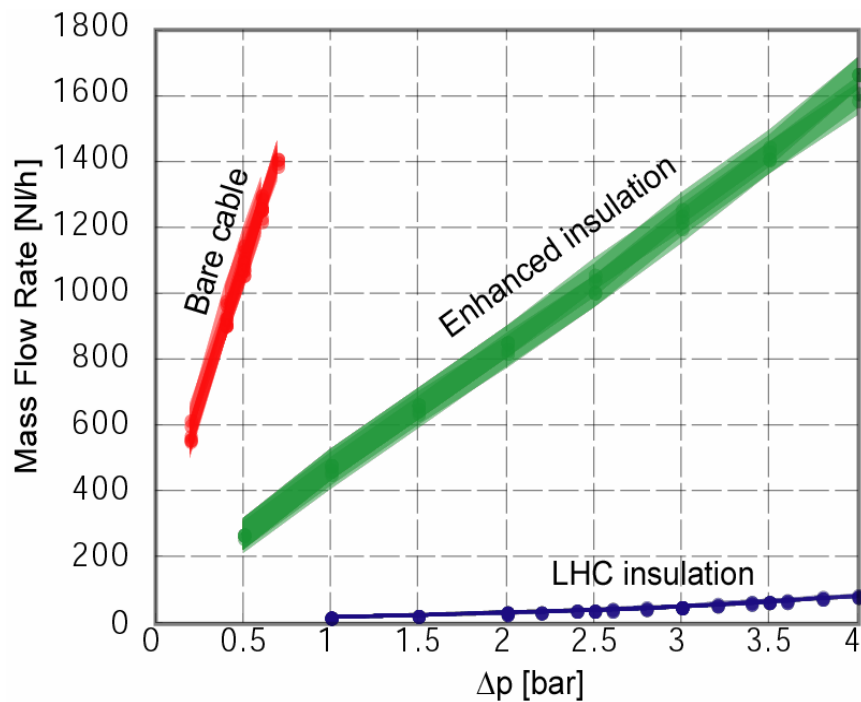


Tests Results: Radial flow

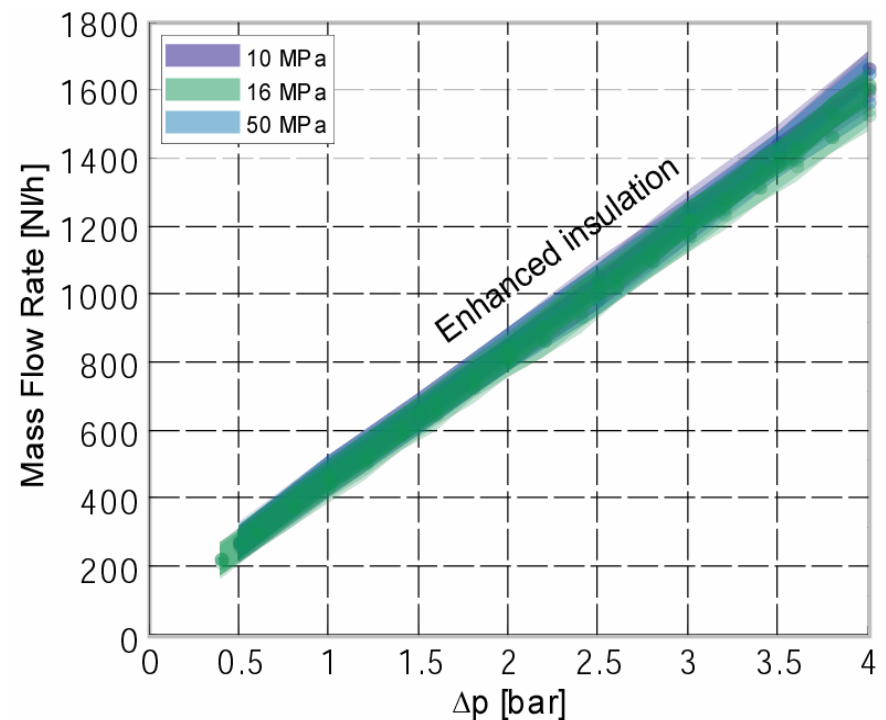


- We show the radial flow rate versus the imposed pressure difference ($\Delta P = P_{\text{inlet}} - P_{\text{outlet}}$).
- Porosity of enhanced insulation is one order of magnitude larger both at 10 and at 50 MPa vertical compression

Vertical compression: 10 MPa

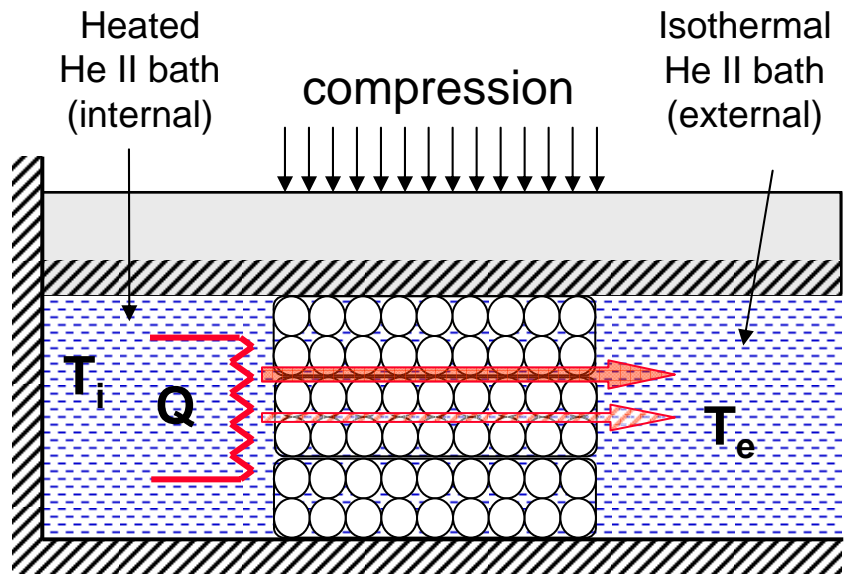




Vertical compression: 10-16-50 MPa



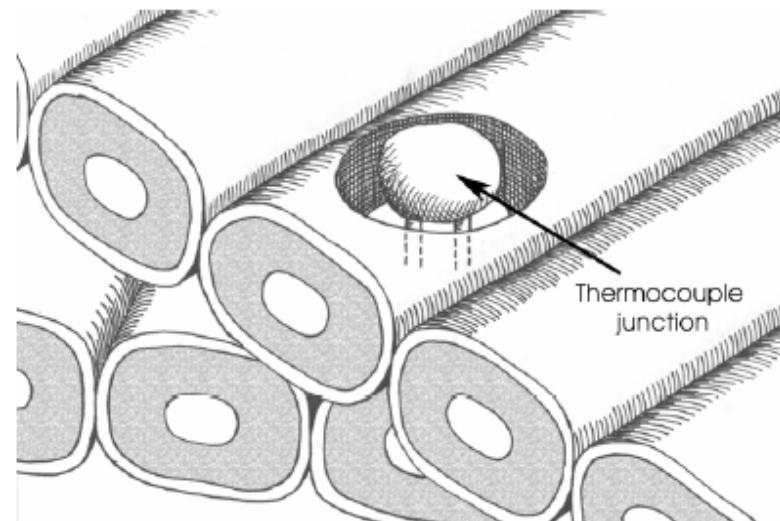
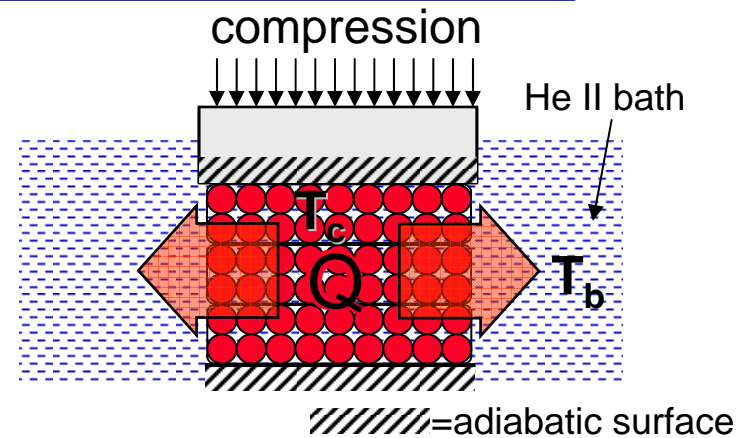


Heat Transfer Tests



 = inter-cable path
 = intra-cable path
 = adiabatic surface

Under way : at Cracow University and at CERN



Courtesy of D. Richter (CERN)



Summary



- The present limitation of heat removal from state of the art insulated NbTi Rutherford cables at 1.9 K is about 85 W/m^2 , corresponding to about 165 mW/m for a LHC main dipole turn.
- There is a large potential to increase the dimension of the cooling channels thus moving their saturation at higher heat fluxes
- This opens new opportunities for using NbTi rutherford cables in costeta structures operating at 1.9 K in presence of heat loads



Thermal Resistances Review



● Thermal boundary resistance at interfaces between different materials (Kapitza):

We use empirical fits q [W/m²], T [K],

→ Cu-He II: $q = 460(T_{\text{Cu}}^{3.46} - T_{\text{He}}^{3.46})$, [7]

→ Kapton-He II: $q = 47.43(T_{\text{Kap}}^4 - T_{\text{He}}^4)$, [8] verified for small ΔT , we use it also for epoxy

→ Cu-epoxy: $q = 1300_{2\text{K}} \div 3600_{6\text{K}}(T_{\text{Cu}} - T_{\text{Ep}})$, [2] consistent with [3]

● Conduction in solids:

→ Kapton: $K = 4.638e-3 * T.^{0.5678}$ [8] verified for $0.5 < T < 5\text{K}$

→ Epoxy+fiberglass: $K = 0.6 * K_{\text{Ep}} + 0.4 * K_{\text{G10}}$, (K_{Ep} & K_{G10} from [9] consistent with [3] and [10])

● He II thermal conductivity

We consider a fully developed Gorter-Mellink regime [4] (conservative hypotheses [5])



References



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